

## Features

- High-Switching Speed, High Current
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- High Conductance
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

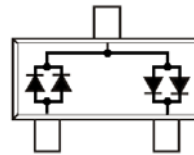
## Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic.  
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208③
- Polarity: See Diagram
- Weight: 0.01 grams (Approximate)

SOT23



Top View



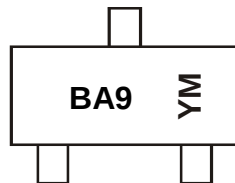
Top View  
Internal Schematic

## Ordering Information (Note 4)

| Part Number | Compliance | Case  | Packaging        |
|-------------|------------|-------|------------------|
| BAS299-7    | Standard   | SOT23 | 3000/Tape & Reel |

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information



BA9 = Product Type Marking Code  
YM = Date Code Marking  
Y = Year (ex: G = 2019)  
M = Month (ex: 9 = September)

### Date Code Key

| Year | 2019 | 2020 | 2021 | 2022 | 2023 | 2024 | 2025 | 2026 |
|------|------|------|------|------|------|------|------|------|
| Code | G    | H    | I    | J    | K    | L    | M    | N    |

| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
|-------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Code  | 1   | 2   | 3   | 4   | 5   | 6   | 7   | 8   | 9   | O   | N   | D   |

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                                                              | Symbol                                                 | Value             | Unit     |
|---------------------------------------------------------------------------------------------|--------------------------------------------------------|-------------------|----------|
| Non-Repetitive Peak Reverse Voltage                                                         | V <sub>RM</sub>                                        | 100               | V        |
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage      | V <sub>RRM</sub><br>V <sub>RWM</sub><br>V <sub>R</sub> | 100               | V        |
| Forward Continuous Current (Note 5)<br>Single diode loaded by design<br>Double diode loaded | I <sub>FM</sub>                                        | 430<br>300        | mA<br>mA |
| Repetitive Peak Forward Current                                                             | I <sub>FRM</sub>                                       | 900               | mA       |
| Non-Repetitive Peak Forward Surge Current<br>@ t = 1.0μs<br>@ t = 1.0ms<br>@ t = 1.0s       | I <sub>FSM</sub>                                       | 9.0<br>3.0<br>1.0 | A        |

**Thermal Characteristics**

| Characteristic                                      | Symbol                            | Value       | Unit |
|-----------------------------------------------------|-----------------------------------|-------------|------|
| Power Dissipation (Note 5)                          | P <sub>D</sub>                    | 300         | mW   |
| Thermal Resistance Junction to Ambient Air (Note 5) | R <sub>θJA</sub>                  | 417         | °C/W |
| Operating and Storage Temperature Range             | T <sub>J</sub> , T <sub>STG</sub> | -65 to +150 | °C   |

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                     | Symbol             | Min | Max                                  | Unit                 | Test Condition                                                                                                                                   |
|------------------------------------|--------------------|-----|--------------------------------------|----------------------|--------------------------------------------------------------------------------------------------------------------------------------------------|
| Reverse Breakdown Voltage (Note 6) | V <sub>(BR)R</sub> | 100 | —                                    | V                    | I <sub>R</sub> = 2.5μA                                                                                                                           |
| Forward Voltage                    | V <sub>F</sub>     | —   | 0.715<br>0.855<br>1.0<br>1.2<br>1.25 | V                    | I <sub>F</sub> = 1.0mA<br>I <sub>F</sub> = 10mA<br>I <sub>F</sub> = 50mA<br>I <sub>F</sub> = 150mA<br>I <sub>F</sub> = 300mA                     |
| Reverse Current (Note 6)           | I <sub>R</sub>     | —   | 30<br>1<br>30<br>60                  | nA<br>μA<br>μA<br>μA | V <sub>R</sub> = 25V<br>V <sub>R</sub> = 100V<br>V <sub>R</sub> = 25V, T <sub>J</sub> = +150°C<br>V <sub>R</sub> = 100V, T <sub>J</sub> = +150°C |
| Total Capacitance                  | C <sub>T</sub>     | —   | 3.0                                  | pF                   | V <sub>R</sub> = 0, f = 1.0MHz                                                                                                                   |
| Reverse Recovery Time              | t <sub>rr</sub>    | —   | 6.0                                  | ns                   | I <sub>F</sub> = I <sub>R</sub> = 10mA,<br>I <sub>rr</sub> = 0.1 × I <sub>R</sub> , R <sub>L</sub> = 100Ω                                        |
| Forward Recovery Voltage           | V <sub>fr</sub>    | —   | 1.75                                 | V                    | When Switched From<br>I <sub>F</sub> = 10mA, t <sub>r</sub> = 20ns                                                                               |

Notes: 5. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at <http://www.diodes.com>.  
6. Short duration pulse test used to minimize self-heating effect.

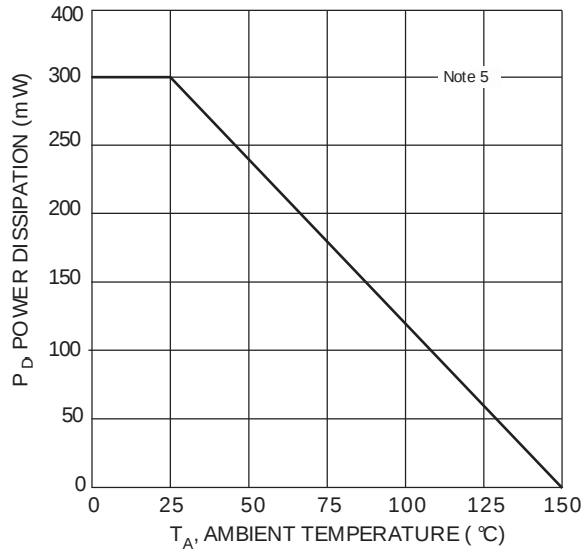


Figure 1 Power Derating Curve, Total Package

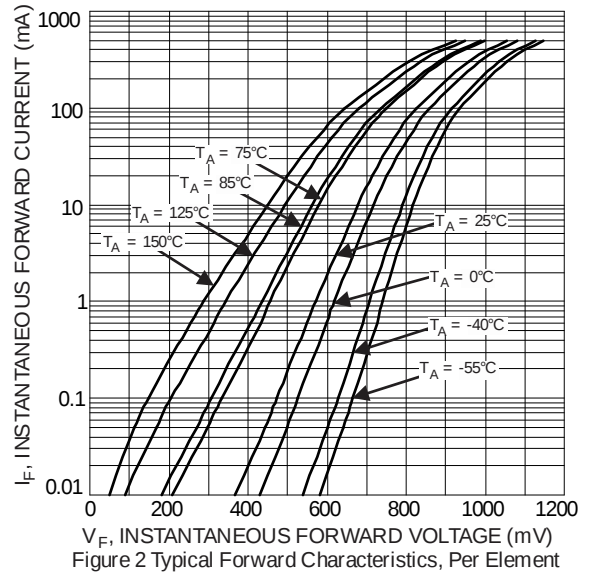


Figure 2 Typical Forward Characteristics, Per Element

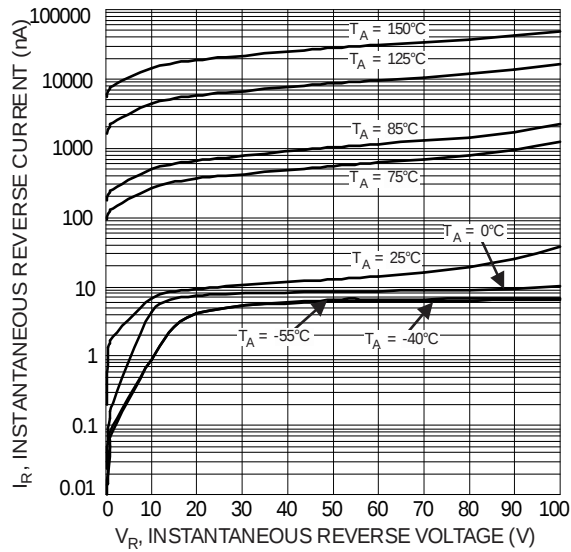


Figure 3 Typical Reverse Characteristics, Per Element

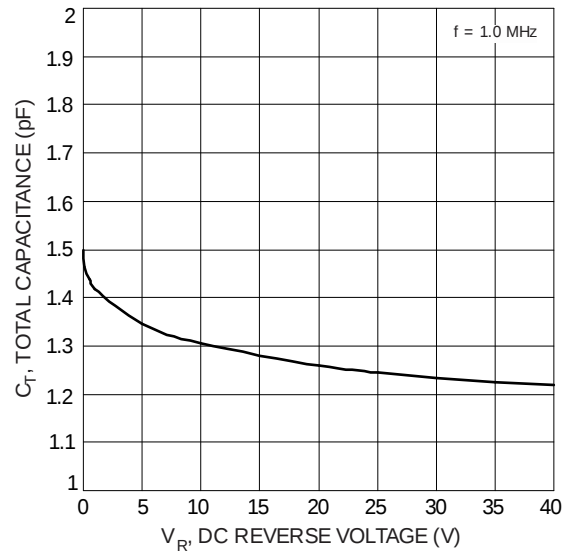
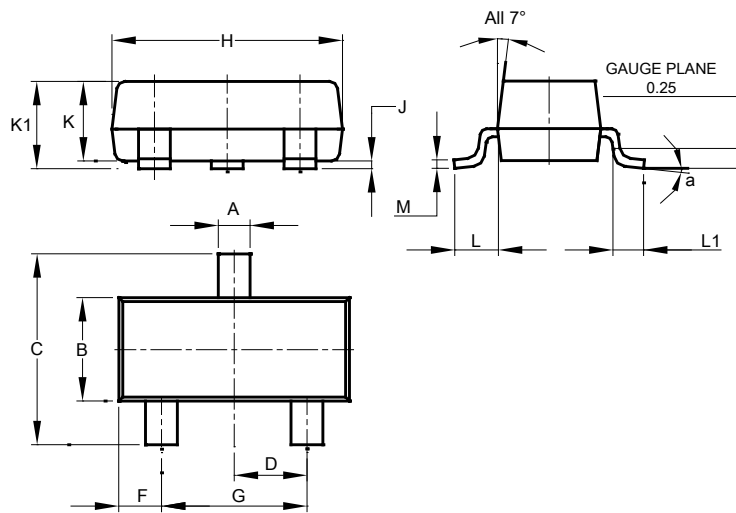


Figure 4 Total Capacitance vs Reverse Voltage, Per Element

## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SOT23**

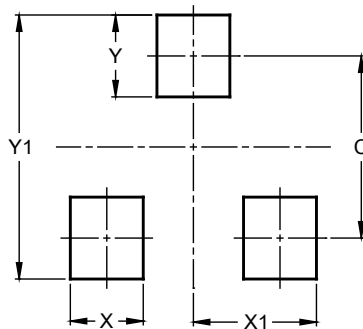


| SOT23                |       |       |       |
|----------------------|-------|-------|-------|
| Dim                  | Min   | Max   | Typ   |
| A                    | 0.37  | 0.51  | 0.40  |
| B                    | 1.20  | 1.40  | 1.30  |
| C                    | 2.30  | 2.50  | 2.40  |
| D                    | 0.89  | 1.03  | 0.915 |
| F                    | 0.45  | 0.60  | 0.535 |
| G                    | 1.78  | 2.05  | 1.83  |
| H                    | 2.80  | 3.00  | 2.90  |
| J                    | 0.013 | 0.10  | 0.05  |
| K                    | 0.890 | 1.00  | 0.975 |
| K1                   | 0.903 | 1.10  | 1.025 |
| L                    | 0.45  | 0.61  | 0.55  |
| L1                   | 0.25  | 0.55  | 0.40  |
| M                    | 0.085 | 0.150 | 0.110 |
| a                    | 0°    | 8°    | --    |
| All Dimensions in mm |       |       |       |

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**SOT23**



| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 2.0           |
| X          | 0.8           |
| X1         | 1.35          |
| Y          | 0.9           |
| Y1         | 2.9           |

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